DIRECT ALUMINUM SOLDERPASTE USING SN100C

- Solders directly to aluminum for aluminum to copper and aluminum to aluminum connections
- Eliminating the need for plating aluminum before soldering
- Good thermal stability for heat sink reflow soldering
- Best results when soldering to 1XXX, 3XXX, and 6XXX series aluminum
- Excellent for stainless steel to stainless steel or stainless steel to aluminum soldering
- Offers the great aluminum solderability of the SN100C alloy

DESCRIPTION

Superior Solder Paste AL2627-103-65 is a water-soluble formulation designed for direct aluminum to aluminum and aluminum to copper soldering of heat sinks. It also has excellent soldering characteristics for stainless steel, copper, and nickel-plated aluminum surfaces. The unique alloying characteristics in the SN100C solder alloy in the paste permits the creation of a true intermetallic bond between the solder and the aluminum.

APPLICATION

Superior Solder Paste AL2627-103-65 is made from Type 3 Powder (-325/+500 Mesh Powder) with a unique flux binding system to keep the active aluminum flux portion from degrading the solder powder. Material should be refrigerated before use and when in storage. Ideal temperature for printing and dispensing the paste is 20°C – 23°C with a relative humidity of 35-55%.

Printing Parameters:
- Squeegee Blade: 80 to 90 durometer polyurethane or stainless steel
- Stencil Material: Stainless Steel, Molybdenum, Nickel Plated, Brass
- Temperature/Humidity: Optimal ranges are 20-25°C and 35-55% Relative Humidity

DIRECTIONS

1. For heat sink applications, Superior Solder Paste AL2627-103-65 is normally via flat printing pattern the heat sink base. Heat pipe in fins have solder paste applied via syringe.
2. Parts are passed through the reflow oven matching the necessary reflow pattern for the mass of the heat sink being soldered. Alternatively induction or hot plate heating can be used.
3. Cleaning of the soldered part should be done in-line with hot water rinse followed by counterflowing cold water rinses then drying. Alternatively, the Superior Aluminum Cleaner can be used in place of the hot water for even more efficient cleaning.
**PHYSICAL PROPERTIES**

Density @ 20°C (68°F) 2.79 grams/liter  
Viscosity @ 20°C (68°F) 500,000 – 600,000 kcps  
Recommended Soldering Range 325°C - 375°C  
Alloy Melting Point 227°C  
Odor Mild  
Flash Point None  
Freezing Point None

**USAGE and STORAGE**

*Superior Solder Paste AL2627-103-65* is a water soluble paste formulation. All equipment in contact with the solder paste can be cleaned with hot water or, more effectively, by hot *Superior Aluminum Cleaner*. The profile, depending on thermal mass, should reach max temp of 325 - 375°C (to fully activate the flux) within 8 min, measuring part surface not the oven temperature.

**Heat Sink Reflow Profile**

*Superior Solder Paste AL2627-103-65* should be stored with consideration of the effect that storage will have on the long term stability of the paste:
- To achieve a shelf life of 12 months, store in a freezer below 0°C.
- To achieve a shelf life of 3-6 months, store in a refrigerator, 1-12°C.
- For non-refrigerated/frozen storage, maintain in a cool and dry location. Maximum temperature should not exceed 23°C. A storage time of up to 3 months can be expected.
- Avoid direct sunlight.

**SAFETY PRECAUTIONS**

*Superior Solder Paste AL2627-103-65* attacks many metals to some extent, it is recommended that polyethylene, PVC or fiberglass reinforced polyester containers be used. Avoid skin contact and/or breathing vapors. Wear gloves and eye protection. This product, during handling or use, may be hazardous to health or the environment. Read the Material Safety Data Sheet and warning label before using this product.

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